EK-TM4C123GXL-BOOST-CC3000 Firmware Development Package

USER'S GUIDE

SW-EK-TM4C123GXL-BOOST-CC3000-UG-2.1.0.12573

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Texas Instruments
108 Wild Basin, Suite 350
Austin, TX 78746
www.ti.com/tiva-c

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1 Introduction

The Texas Instruments® Tiva™ C Series EK-TM4C123GXL-BOOST-CC3000 evaluation board is a low cost platform that can be used for software development and to prototype a hardware design. It contains a Tiva C Series ARM® Cortex™-M4F-based microcontroller, a USB device port, two push buttons, and a RGB LED that can be used to exercise the peripherals on the microcontroller. Additionally, most of the microcontroller's pins are brought to headers, allowing for easy connection to other hardware for the purposes of prototyping. The outer rows of header pins are compatible with the MSP430™ Launchpad.

This document describes the example applications that are provided for this evaluation board when paired with the BOOST-CC3000 BoosterPack.

2 Example Applications

The example applications show how to use features of the Cortex-M4F microprocessor, the peripherals on the Tiva C Series microcontroller, and the drivers provided by the peripheral driver library. These applications are intended for demonstration and as a starting point for new applications.

There is an IAR workspace file (`ek-tm4c123gxl-boost-cc3000.eww`) that contains the peripheral driver library project, USB library project, and all of the board example projects, in a single, easy to use workspace for use with Embedded Workbench version 6.

There is a Keil multi-project workspace file (`ek-tm4c123gxl-boost-cc3000.mpw`) that contains the peripheral driver library project, USB library project, and all of the board example projects, in a single, easy to use workspace for use with uVision.

All of these examples reside in the `examples/boards/ek-tm4c123gxl-boost-cc3000` subdirectory of the firmware development package source distribution.

2.1 CC3000 Basic WiFi Example (cc3000_basic_wifi_application)

This is a basic WiFi application for the CC3000 BoosterPack. This application is a command line wrapper for various functions that the CC3000 can provide. Please refer to the CC3000 wiki at `http://processors.wiki.ti.com/index.php/CC3000` for more information on the commands provided.

To see available commands type “help” at the serial terminal prompt. The terminal is connected in 8-N-1 mode at 115200 baud.

To use this example you must first connect to an existing unencrypted wireless network. This can be done by using the “smartconfig” command with the associated smartphone application. Alternatively, the connection can be made manually by using the ’connect’ command. Once connected you can do any of the following.

Configure an IP address:

1. To use DHCP to allocate a dynamic IP address “ipconfig” or “ipconfig 0 0 0” or,
2. To allocate a static IP address use “ipconfig a.b.c.d” where “a.b.c.d” is the required, dotted-decimal format address.

Send and receive UDP data:

1. Open a UDP socket “socketopen UDP”.
2. Bind the socket to a local port “bind 8080”.
3. Send or receive data “senddata 192.168.1.101 8080 helloworld” or “receivedata”. In the senddata case, the provided parameters identify the IP address of the remote host and the remote port number to which the data is to be sent.

Send and receive TCP data:

1. Open a TCP socket “socketopen TCP”.
2. Bind the socket to a local port “bind 8080”.

3. Send a request to the remote server “senddata 192.168.1.101 8080 helloworld”. On the first “senddata” after opening the socket, the socket is connected to the specified remote host and port. On further “senddata” requests, the remote address and port are ignored and the existing connection is used.
4. Receive data from the remote server “receivedata”.

Note that, in the current implementation, the application only supports acting as a TCP client. The CC3000 also supports incoming connections as required to operate as a TCP server but this example does not yet include support for this feature.

Send mDNS advertisement:

1. “mdnsadvertise cc3000”

Close the open socket:

1. “socketclose”

Disconnect from network:

1. “disconnect”

Reset the CC3000:

1. “resetcc3000”

Delete connection policy:

This deletes the connection policy from CC3000 memory so that the device won’t auto connect whenever it is reset in future.

1. “deletepolicy”

2.2 CC3000 Firmware Patch Programmer (cc3000_patch_programmer)

This is the Patch Programmer tool for the CC3000 BoosterPack running on an EK-TM4C123GXL LaunchPad. Run the application to download new firmware and driver patches to the CC3000 processor. When run the LED on the board will glow red for up to 10 seconds, then the led will turn blue when the firmware update is complete. Status is also output via UART0 which is available via the virtual COM port provided by the ICDI debug interface.

Two patches are downloaded using this tool with the patch data is linked directly into the application binary. The driver patch can be found in an array named “wlan_drv_patch” and the firmware patch can be found in “fw_patch”. When new patches are available, these arrays must be replaced with versions containing those new patches and then the application rebuilt and run to apply the patches to the CC3000 hardware.

To view output from the application, set your host system’s serial terminal to use 115200bps, 8-N-1.

For information on the CC3000 software stack and API, please consult the wiki at `http://processors.wiki.ti.com/index.php/CC3000`.

2.3 CC3000 WiFi Access Point SSID Scanning Example (cc3000_ssid_scan)

This example requires a CC3000 WiFi BoosterPack attached to the EK-TM4C123GXL LaunchPad. After booting and initializing the CC3000, the application initiates a WiFi scan for access points. When the scan completes, the SSID, BSSID and security protocol supported by each detected access point are output on the UART0 connection available over the virtual COM port connection provided by the board's ICDI debug interface.

To view output from the application, set your host system's serial terminal to use 115200bps, 8-N-1.

For information on the CC3000 software stack and API, please consult the wiki at `http://processors.wiki.ti.com/index.php/CC3000`.

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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265